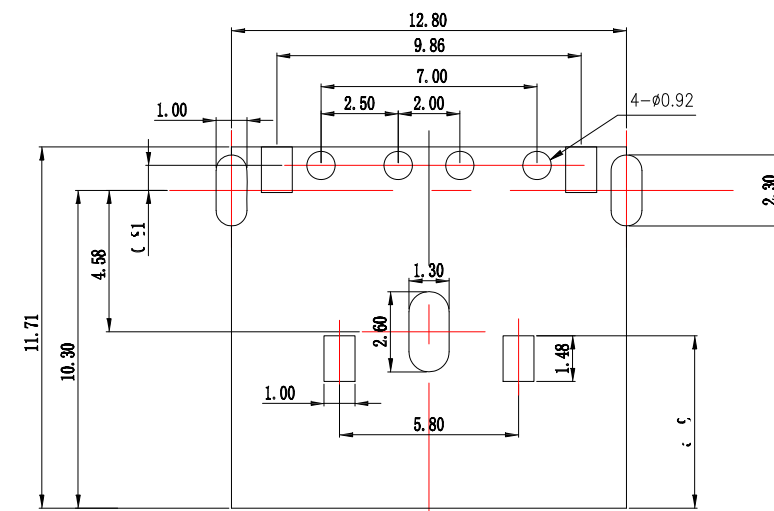
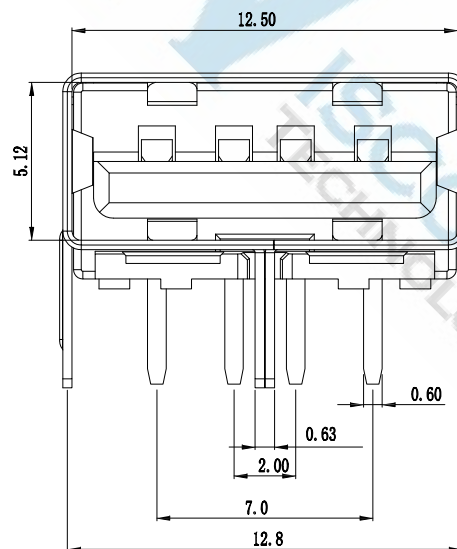




NOTE:

- 1.Material:
Housing:PBT+30%G/F(UL94V-0)
Contact:PHOSPHOR BRONZE,
Shell: BRASS,
- 2.Finish:
Contact:AU Plating on contact area.
TIN(Pb free) Plating on solder tails area.
Ni Plating all over.
SHELL: Ni Plating all over.



DIMENSIONS TOLERANCE <u>METRIC</u> $0. \pm 0.30$ 0.0 ± 0.20 0.000 ± 0.10 $ANG. = \pm 2^\circ$	單位(UNITS)	MM	處理(FINISH)	SEE NOTE	審校(CH'K)	Calvin	圖名(NAME) USB A/F 11.7短體反向90度 DIP(平口)		WISCONN Technology Co.,Ltd Tel:02-2742-1798 Fax:02-2742-1898							
	數量(QT'Y)	N/A	繪圖(DRAW)	Johnson	核准(APP'D)	Selena	料號(PART NUMBER)	WU2AF-04FPxDRP-11.7R								
	材料(MT'L)	SEE NOTE	設計(DE'N)	Mike	日期 DATE)	OCT.15.2007	圖號(DRAW NUMBER)	T002	比例 (SCALE)	1/1	圖紙 (SIZE)	A4	頁次 (SHEET)	1	版次 (REV.)	A
							圖檔(FILE NAME .DWG)									